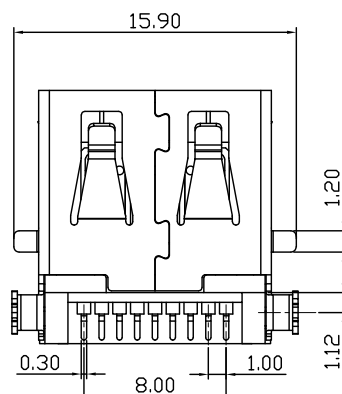
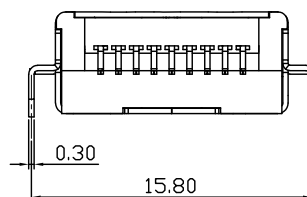
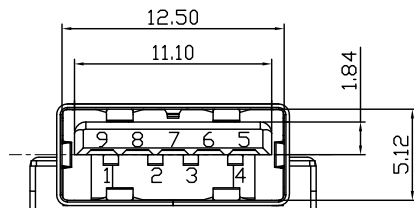


NOTES:

1.MATERIAL:

- 1.1 HOUSING: HIGH TEMPERATURE THERAL PLASTIC.
1.2 SPRING CONTACT: COPPER ALLOY.
1.3 FLAT CONTACT: COPPER ALLOY
1.4 SHELL : COPPER ALLOY.

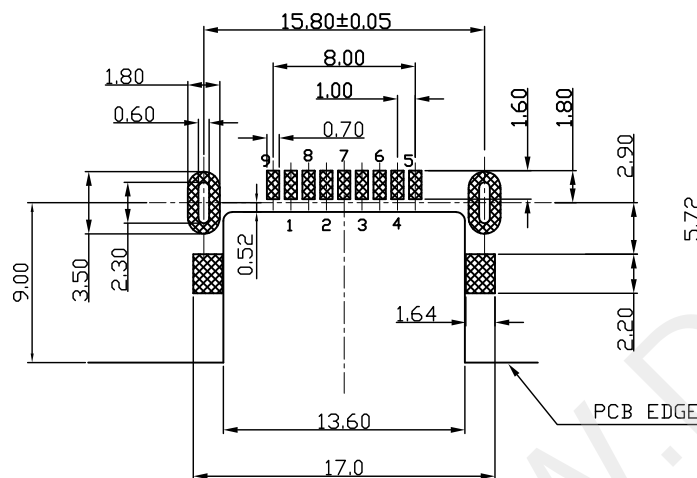
2.FINISH:

- 2.1 CONTACT: (SEE P/N.),[50μ"] MIN. NICKEL UNDERPLATING OVER ALL.
2.2 SHELL: [50μ"] MIN.SOLDERABILITY NICKEL UNDERPLATING OVER ALL.

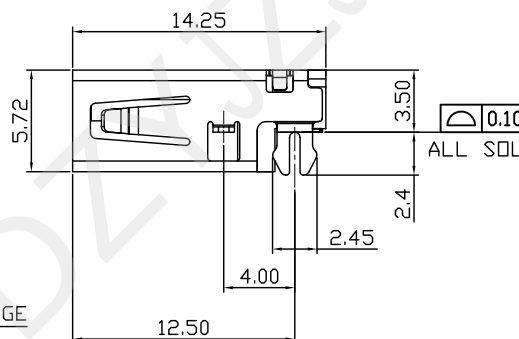
PIN NO.	PIN 1	PIN 2	PIN 3	PIN 4
SLGNAL NAME	V BUS	D-	D+	GND
REMARK	USB 2.0 CONTACT PINS			

PIN NO.	PIN 5	PIN 6	PIN 7	PIN 8	PIN 9
SLGNAL NAME	STDA_SSRX-	STDA_SSRX+	GND_DRAIN	STDA_SSTX-	STDA_SSTX+
REMARK	USB 3.0 CONTACT PINS				

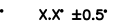
ALL SOLDER TAILS



TOLERANCE: ± 0.05 ,
RECOMMENDED PCB LAYOUT
(TOP VIEW)



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*				USB 3.0 AF 沉板 鱼叉脚 无卷边	
 UNIT: mm [inch]		CHECKED BY:	DATE :	PART NO.	HYC147-USBA09-350
		马跃	2014-02-23	MOLD NO.	
				APPROVED BY:	DATE :
SCALE:1:1	SIZE: A4	邱敏	2014-02-23	SHEET NO.	1 OF 1